

Maximum Ratings (@T_A = +25°C, unless otherwise specified)

| Characteristic | | | Symbol | Value | Unit |
|----------------------------------------------------------|-----------------|----------------------------------|-----------------|------------|------|
| Drain-Source Voltage | | | V_{DSS} | 12 | V |
| Gate-Source Voltage | | | V_{GSS} | ±8 | V |
| Continuous Drain Current (Note 6) V _{GS} = 4.5V | Steady State | $T_A = +25$ °C $T_A = +70$ °C | I _D | 3.2 2.5 | А |
| Pulsed Drain Current (10μs pulse, Duty cycle = 1%) | | | I _{DM} | 15 | A |

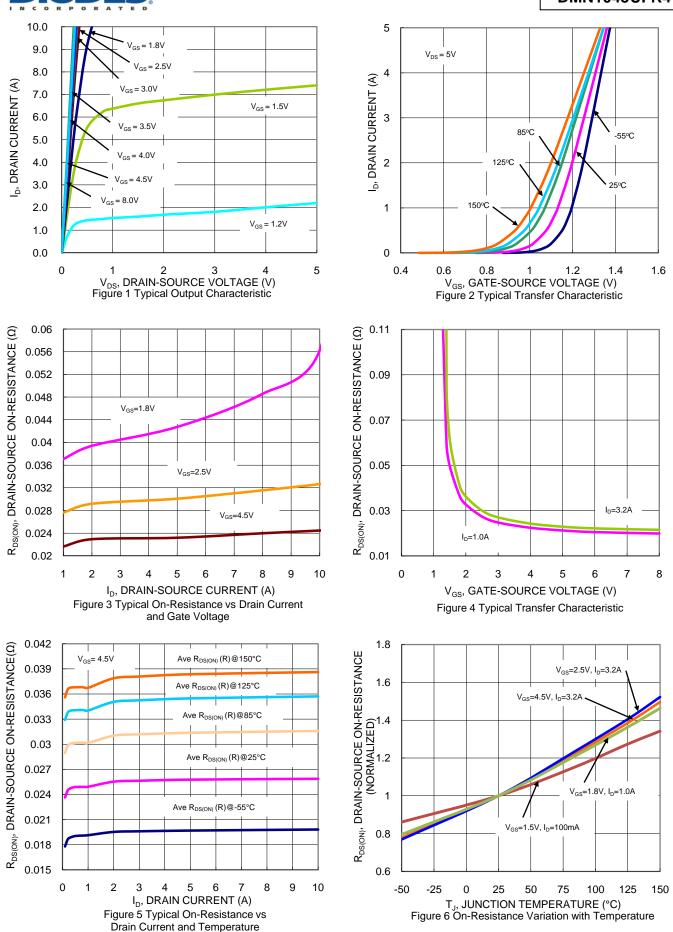
Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|--------------------------------------------------------------------------|----------------------------------|-------------|------|
| Total Power Dissipation (Note 5) | P_{D} | 0.5 | W |
| Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 5) | $R_{\theta JA}$ | 251 | °C/W |
| Total Power Dissipation (Note 6) | P_{D} | 1.26 | W |
| Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 6) | $R_{\theta JA}$ | 99 | °C/W |
| Operating and Storage Temperature Range | T _{J,} T _{STG} | -55 to +150 | °C |

Electrical Characteristics (@TA = +25°C, unless otherwise specified)

| Characteristic | Symbol | Min | Tym | Max | Unit | Test Condition | |
|-----------------------------------|---------------------|--------|-----|-------|------|-------------------------------------------------------------------------|--|
| OFF CHARACTERISTICS (Note 7) | Syllibol | IVIIII | Тур | IVIAX | Unit | rest Condition | |
| , , | D) (| 40 | | | | N/ 01/ 1 050 A | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 12 | _ | _ | V | $V_{GS} = 0V, I_D = 250 \mu A$ | |
| Zero Gate Voltage Drain Current | I _{DSS} | _ | _ | 1 | μΑ | $V_{DS} = 12V$, $V_{GS} = 0V$ | |
| Gate-Source Leakage | I_{GSS} | _ | _ | ±10 | μΑ | $V_{GS} = \pm 8V, V_{DS} = 0V$ | |
| ON CHARACTERISTICS (Note 7) | | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | 0.4 | | 1.0 | V | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | |
| | R _{DS(ON)} | _ | 25 | 45 | mΩ | $V_{GS} = 4.5V, I_D = 3.2A$ | |
| Static Drain-Source On-Resistance | | | 32 | 64 | | $V_{GS} = 2.5V, I_D = 3.2A$ | |
| Static Drain-Source On-Resistance | | | 40 | 85 | | $V_{GS} = 1.8V, I_D = 1A$ | |
| | | | 50 | 100 | | $V_{GS} = 1.5V, I_D = 0.1A$ | |
| Diode Forward Voltage | V_{SD} | | _ | 1.2 | V | V _{GS} = 0V, I _S = 1.0A | |
| DYNAMIC CHARACTERISTICS (Note 8) | | | | | | | |
| Input Capacitance | C _{iss} | | 375 | | pF | V _{DS} = 10V, V _{GS} = 0V, f = 1.0MHz | |
| Output Capacitance | Coss | | 57 | | pF | | |
| Reverse Transfer Capacitance | C _{rss} | | 51 | _ | pF | | |
| Total Gate Charge | Q_{g} | | 4.8 | | nC | $V_{GS} = 4.5V, V_{DS} = 10V$ $I_D = 3.2A$ | |
| Gate-Source Charge | Qgs | | 0.6 | | nC | | |
| Gate-Drain Charge | Q_{gd} | | 1.2 | | nC | | |
| Turn-On Delay Time | t _{D(on)} | _ | 7 | _ | ns | V_{DD} = 10V, V_{GEN} = 4.5V, R_{GEN} = 6 Ω , I_D = 3.2A | |
| Turn-On Rise Time | t _r | _ | 25 | | ns | | |
| Turn-Off Delay Time | t _{D(off)} | | 93 | | ns | | |
| Turn-Off Fall Time | t _f | | 48 | _ | ns | | |

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
- 6. Device mounted on 1" x 1" FR-4 PCB with high coverage 2oz. Copper, single sided.
 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to production testing.



100

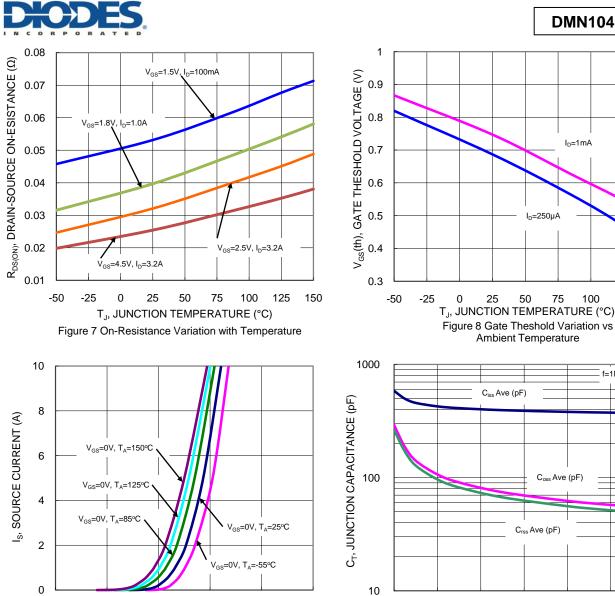
125

f=1MHz

10

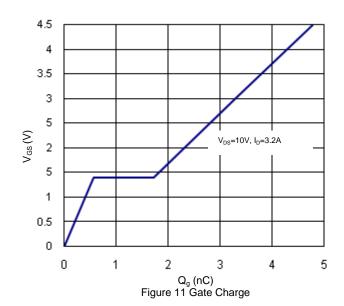
12

150



1.5

0



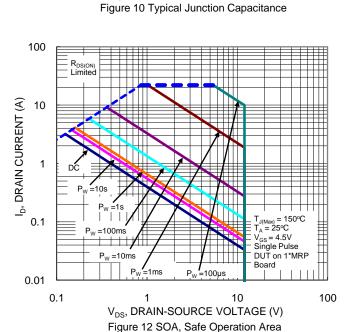
0.6

V_{SD}, SOURCE-DRAIN VOLTAGE (V)

Figure 9 Diode Forward Voltage vs. Current

0.9

1.2



6

V_{DS}, DRAIN-SOURCE VOLTAGE (V)

8

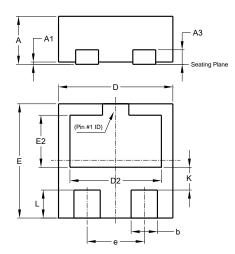
0

0.3



Package Outline Dimensions

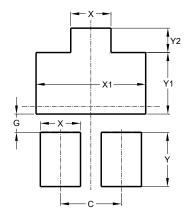
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



| X2-DFN1010-3 | | | | | |
|----------------------|-------|-------|-------|--|--|
| Dim | Min | Max | Тур | | |
| Α | - | 0.40 | 0.39 | | |
| A1 | 0.00 | 0.05 | 0.02 | | |
| A3 | - | - | 0.13 | | |
| b | 0.18 | 0.28 | 0.23 | | |
| D | 0.95 | 1.05 | 1.00 | | |
| D2 | 0.70 | 0.90 | 0.80 | | |
| E | 0.95 | 1.05 | 1.00 | | |
| E2 | 0.36 | 0.56 | 0.46 | | |
| е | - | - | 0.50 | | |
| K | - | - | 0.20 | | |
| Ĺ | 0.195 | 0.295 | 0.245 | | |
| All Dimensions in mm | | | | | |

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| X2-DFN1010-3 | | | |
|----------------------|-------|--|--|
| Dimensions | Value | | |
| С | 0.500 | | |
| G | 0.150 | | |
| Х | 0.330 | | |
| X1 | 0.900 | | |
| Υ | 0.445 | | |
| Y1 | 0.505 | | |
| Y2 | 0.200 | | |
| All Dimensions in mm | | | |



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